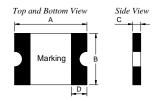
1. Physical Dimensions(size of 1812)

Unit:mm

Part Number	A		В		С		D	Montrino	
	Min	Max	Min	Max	Min	Max	Min	Marking	
K1812L150/16PR	4.37	4.73	3.07	3.41	0.45	0.85	0.30	T150	



2, Electrical Characteristics

Part Number	I _H (A)	I _T (A)	V _{max} (V)	I max (A)	Ttrip (Max time to trip) Current(A) Time(S)		Pd _{typ} (W)	R _{min} (Ω)	$R1_{max}$ (Ω)
K1812L150/16PR	1.50	3.00	16	100	8.0	0.50	1.0	0.030	0.120

I_H: Holding Current: maximum current at which the device will not trip in 25 ℃ still air.

 I_T : Tripping Current minimum current at which the device will trip in 25 $^{\circ}$ C still air.

V_{max}: Maximum voltage device can withstand without damage at rated current.

I max: Maximum fault current device can withstand without damage at rated voltage.

T trip: Maximum time to trip(s) at assigned current.

Pd_{typ}: Rated working power.

R $_{\text{min}}$: Minimum resistance of device prior to trip at 25 $^{\circ}\text{C}$.

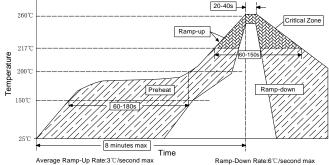
R1 $_{max}$: Maximum resistance of device is measured one hours post reflow at 25 $^{\circ}$ C.

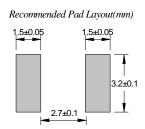
Noted: All electrical function test is conducted after PCB mounted.

3. Thermal Derating

K1913I 150/16DD	Maximum ambient operating temperature									
K1812L150/16PR	-40°C	-20°C	0℃	25℃	40°C	50°C	60°C	70°C	85℃	
Hold Current(A)	2.17	1.95	1.72	1.50	1.30	1.18	1.09	0.97	0.82	
Trip Current(A)	4.34	3.90	3.44	3.00	2.60	2.36	2.18	1.94	1.64	

4. Solder Reflow Recommendations





Notes:If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

5. Package Information

Packing quantity:2000PCS/Reel

Note: Reel packaging per EIA-481-1 standard

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